LM148,LM248,LM348

LM148/LM248/LM348 Quad 741 Op Amps



Literature Number: SNOSBT2D

30 nA

120 dB

November 2003

N**ational** Semiconductor LM148/LM248/LM348 Quad 741 Op Amps

General Description

The LM148 series is a true quad 741. It consists of four independent, high gain, internally compensated, low power operational amplifiers which have been designed to provide functional characteristics identical to those of the familiar 741 operational amplifier. In addition the total supply current for all four amplifiers is comparable to the supply current of a single 741 type op amp. Other features include input offset currents and input bias current which are much less than those of a standard 741. Also, excellent isolation between amplifiers has been achieved by independently biasing each amplifier and using layout techniques which minimize thermal coupling.

The LM148 can be used anywhere multiple 741 or 1558 type amplifiers are being used and in applications where amplifier matching or high packing density is required. For lower power refer to LF444.

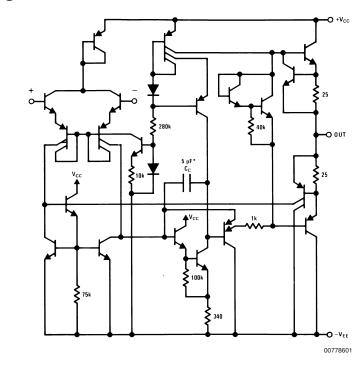
Schematic Diagram

* 1 pF in the LM149

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- 741 op amp operating characteristics
- Class AB output stage—no crossover distortion
- Pin compatible with the LM124
- Overload protection for inputs and outputs
- 0.6 mA/Amplifier Low supply current drain:
- Low input offset voltage: 1 mV 4 nA
- Low input offset current:
- Low input bias current
- High degree of isolation between amplifiers:
- Gain bandwidth product
- 1.0 MHz LM148 (unity gain):



Absolute Maximum Ratings (Note 4)

Distributors for availability and specifications.

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/

	LM148	LM248	LM348
Supply Voltage	±22V	±18V	±18V
Differential Input Voltage	±44V	±36V	±36V
Output Short Circuit Duration (Note 1)	Continuous	Continuous	Continuous
Power Dissipation (P _d at 25°C) and			
Thermal Resistance (θ_{jA}), (Note 2)			
Molded DIP (N) P _d	_	_	750 mW
θ_{jA}	—	—	100°C/W
Cavity DIP (J) P _d	1100 mW	800 mW	700 mW
θ_{JA}	110°C/W	110°C/W	110°C/W
Maximum Junction Temperature (T _{jMAX})	150°C	110°C	100°C
Operating Temperature Range	$-55^{\circ}C \leq T_A \leq +125^{\circ}C$	$-25^{\circ}C \leq T_A \leq +85^{\circ}C$	$0^{\circ}C \leq T_A \leq +70^{\circ}C$
Storage Temperature Range	–65°C to +150°C	–65°C to +150°C	–65°C to +150°C
Lead Temperature (Soldering, 10 sec.) Ceramic	300°C	300°C	300°C
Lead Temperature (Soldering, 10 sec.) Plastic			260°C
Soldering Information			
Dual-In-Line Package			
Soldering (10 seconds)	260°C	260°C	260°C
Small Outline Package			
Vapor Phase (60 seconds)	215°C	215°C	215°C
Infrared (15 seconds)	220°C	220°C	220°C
See AN-450 "Surface Mounting Methods and Their I	Effect on Product Reliability	y" for other methods of s	oldering surface
mount			
devices.			
ESD tolerance (Note 5)	500V	500V	500V

Electrical Characteristics

(Note 3)

Parameter	Conditions	LM148		LM248			LM348			Units	
		Min	Тур	Max	Min	Тур	Мах	Min	Тур	Max	
Input Offset Voltage	$T_A = 25^{\circ}C, R_S \le 10 \text{ k}\Omega$		1.0	5.0		1.0	6.0		1.0	6.0	mV
Input Offset Current	$T_A = 25^{\circ}C$		4	25		4	50		4	50	nA
Input Bias Current	$T_A = 25^{\circ}C$		30	100		30	200		30	200	nA
Input Resistance	$T_A = 25^{\circ}C$	0.8	2.5		0.8	2.5		0.8	2.5		MΩ
Supply Current All Amplifiers	$T_{A} = 25^{\circ}C, V_{S} = \pm 15V$		2.4	3.6		2.4	4.5		2.4	4.5	mA
Large Signal Voltage Gain	$T_{A} = 25^{\circ}C, V_{S} = \pm 15V$	50	160		25	160		25	160		V/mV
	$V_{OUT} = \pm 10V, R_L \ge 2 \ k\Omega$										
Amplifier to Amplifier	$T_A = 25^{\circ}C$, f = 1 Hz to 20 kHz										
Coupling	(Input Referred) See Crosstalk		-120			-120			-120		dB
	Test Circuit										
Small Signal Bandwidth	T _A = 25°C,		1.0			1.0			1.0		MHz
	LM148 Series										
Phase Margin	T _A = 25°C,		60			60			60		degrees
	LM148 Series $(A_V = 1)$										
Slew Rate	$T_A = 25^{\circ}C,$		0.5			0.5			0.5		V/µs
	LM148 Series ($A_V = 1$)										
Output Short Circuit Current	$T_A = 25^{\circ}C$		25			25			25		mA
Input Offset Voltage	$R_{S} \le 10 \text{ k}\Omega$			6.0			7.5			7.5	mV
Input Offset Current				75			125			100	nA

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Electrical Characteristics (Continued)

(Note 3)

Parameter	Conditions		LM148		LM248			LM348			Units
		Min	Тур	Мах	Min	Тур	Мах	Min	Тур	Мах	
Input Bias Current				325			500			400	nA
Large Signal Voltage Gain	$V_{\rm S} = \pm 15 V, V_{\rm OUT} = \pm 10 V,$	25			15			15			V/mV
	$R_L > 2 k\Omega$										
Output Voltage Swing	$V_{\rm S} = \pm 15 V, R_{\rm L} = 10 \text{ k}\Omega$	±12	±13		±12	±13		±12	±13		V
	$R_{L} = 2 k\Omega$	±10	±12		±10	±12		±10	±12		V
Input Voltage Range	$V_{\rm S} = \pm 15 V$	±12			±12			±12			V
Common-Mode Rejection	$R_{s} \le 10 \text{ k}\Omega$	70	90		70	90		70	90		dB
Ratio											
Supply Voltage Rejection	$R_{S} \le 10 \text{ k}\Omega, \pm 5V \le V_{S} \le \pm 15V$	77	96		77	96		77	96		dB

Note 1: Any of the amplifier outputs can be shorted to ground indefinitely; however, more than one should not be simultaneously shorted as the maximum junction temperature will be exceeded.

Note 2: The maximum power dissipation for these devices must be derated at elevated temperatures and is dicated by T_{JMAX} , θ_{JA} , and the ambient temperature, T_A . The maximum available power dissipation at any temperature is $P_d = (T_{JMAX} - T_A)/\theta_{JA}$ or the 25°C P_{DMAX} , whichever is less.

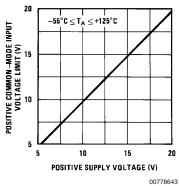
Note 3: These specifications apply for $V_S = \pm 15V$ and over the absolute maximum operating temperature range ($T_L \le T_A \le T_H$) unless otherwise noted.

Note 4: Refer to RETS 148X for LM148 military specifications.

Note 5: Human body model, 1.5 k Ω in series with 100 pF.

Cross Talk Test Circuit V_s = ±15V





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00778607



Typical Performance Characteristics Supply Current Input Bias Current 90 6 80 5 INPUT BIAS CURRENT (nA) SUPPLY CURRENT (mA) 70 4 60 +25°C 50 ±20 V_S 3 40 2 30 20 +125°C 1 10 0 0 0 10 15 20 -55 -35 -15 5 25 SUPPLY VOLTAGE (±V) TEMPERATURE (°C) 00778623 Voltage Swing **Positive Current Limit** 50 15 POSITIVE OUTPUT VOLTAGE SWING (V) PEAK TO PEAK OUTPUT SWING (V) T_A = 25°C 40 10 30 20 5 +125° 10 0 0 10 15 20 25 0 5 0 10 15 5 SUPPLY VOLTAGE (+V) **OUTPUT SOURCE CURRENT (mA)** 00778625 **Negative Current Limit Output Impedance** -15 1k **NEGATIVE OUTPUT VOLTAGE SWING(V)** V_S = ±15V $V_S = \pm 15V$ = 25°C **OUTPUT IMPEDANCE** (12) 100 -55°C -10 +25[°] 10 -5 +125°Ċ 0.1 0 100 1k 10k 15 30 0 5 10 20 25 FREQUENCY (Hz) **OUTPUT SINK CURRENT (mA)** 00778627

15 V

45 65 85 105 125

±10 Vs

00778624

= ±15 ٧s

-55°C

25

30

00778626

+25°C

20

100k

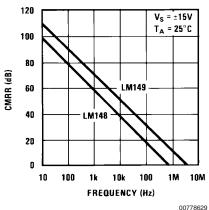
1M

00778628

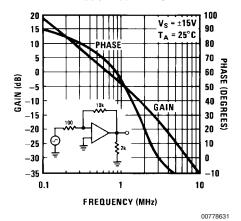
LM148/LM248/LM348

Typical Performance Characteristics (Continued)

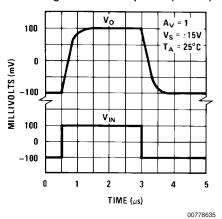




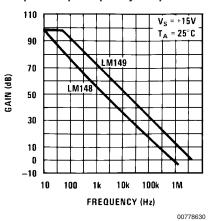




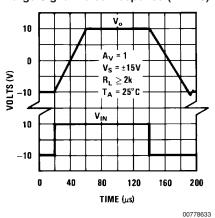
Small Signal Pulse Response (LM148)



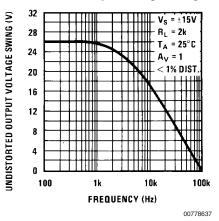
Open Loop Frequency Response





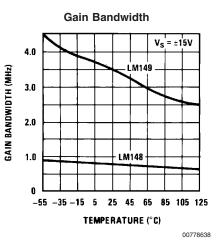


Undistorted Output Voltage Swing

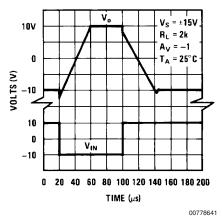


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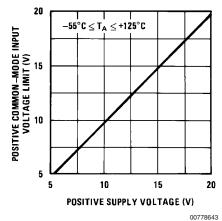
Typical Performance Characteristics (Continued)

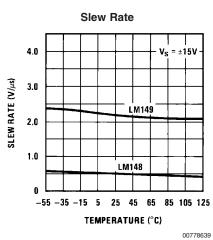




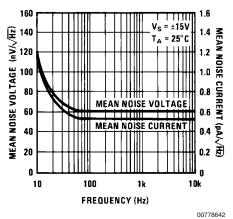




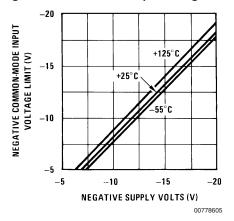




Input Noise Voltage and Noise Current



Negative Common-Mode Input Voltage Limit



Application Hints

The LM148 series are quad low power 741 op amps. In the proliferation of quad op amps, these are the first to offer the convenience of familiar, easy to use operating characteristics of the 741 op amp. In those applications where 741 op amps have been employed, the LM148 series op amps can be employed directly with no change in circuit performance.

The package pin-outs are such that the inverting input of each amplifier is adjacent to its output. In addition, the amplifier outputs are located in the corners of the package which simplifies PC board layout and minimizes package related capacitive coupling between amplifiers.

The input characteristics of these amplifiers allow differential input voltages which can exceed the supply voltages. In addition, if either of the input voltages is within the operating common-mode range, the phase of the output remains correct. If the negative limit of the operating common-mode range is exceeded at both inputs, the output voltage will be positive. For input voltages which greatly exceed the maximum supply voltages, either differentially or common-mode, resistors should be placed in series with the inputs to limit the current.

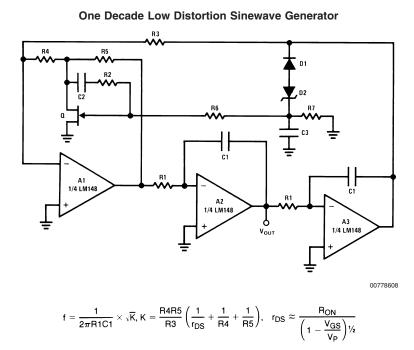
Like the LM741, these amplifiers can easily drive a 100 pF capacitive load throughout the entire dynamic output voltage and current range. However, if very large capacitive loads must be driven by a non-inverting unity gain amplifier, a resistor should be placed between the output (and feedback connection) and the capacitance to reduce the phase shift resulting from the capacitive loading.

The output current of each amplifier in the package is limited. Short circuits from an output to either ground or the power supplies will not destroy the unit. However, if multiple output shorts occur simultaneously, the time duration should be short to prevent the unit from being destroyed as a result of excessive power dissipation in the IC chip.

As with most amplifiers, care should be taken lead dress, component placement and supply decoupling in order to ensure stability. For example, resistors from the output to an input should be placed with the body close to the input to minimize "pickup" and maximize the frequency of the feedback pole which capacitance from the input to ground creates.

A feedback pole is created when the feedback around any amplifier is resistive. The parallel resistance and capacitance from the input of the device (usually the inverting input) to AC ground set the frequency of the pole. In many instances the frequency of this pole is much greater than the expected 3 dB frequency of the closed loop gain and consequently there is negligible effect on stability margin. However, if the feedback pole is less than approximately six times the expected 3 dB frequency a lead capacitor should be placed from the output to the input of the op amp. The value of the added capacitor should be such that the RC time constant of this capacitor and the resistance it parallels is greater than or equal to the original feedback pole time constant.

Typical Applications—LM148



 f_{MAX} = 5 kHz, THD $\leq 0.03\%$

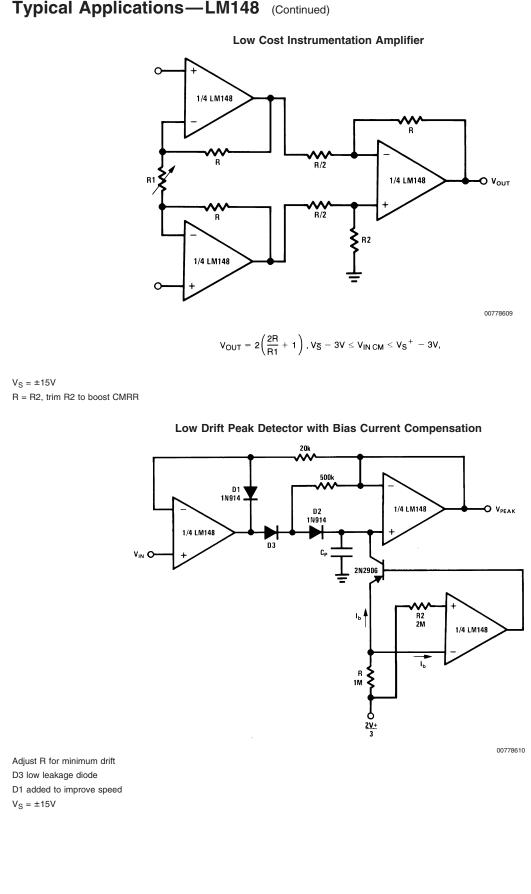
R1 = 100k pot. C1 = 0.0047 μ F, C2 = 0.01 μ F, C3 = 0.1 μ F, R2 = R6 = R7 = 1M,

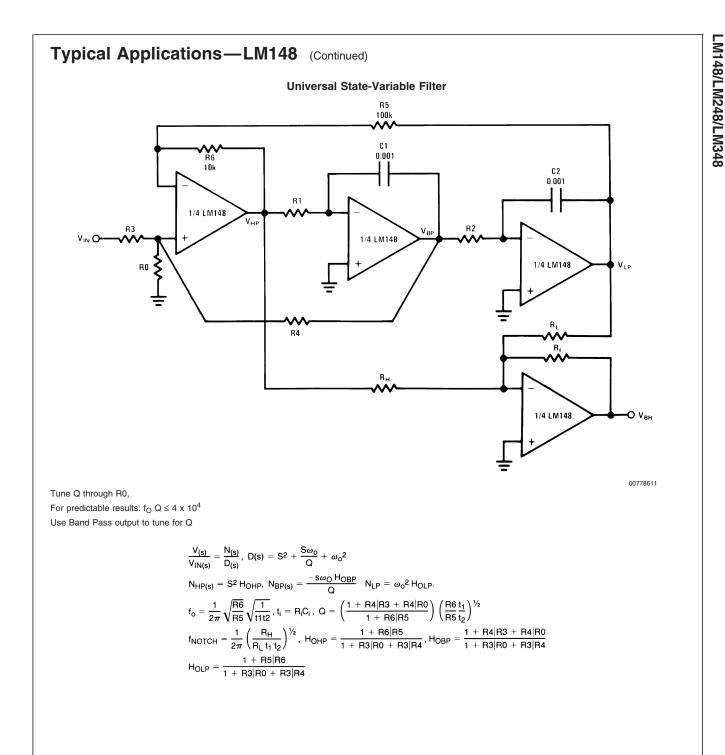
R3 = 5.1k, $R4 = 12\Omega$, $R5 = 240\Omega$, Q = NS5102, D1 = 1N914, D2 = 3.6V avalanche

diode (ex. LM103), $V_S = \pm 15V$

A simpler version with some distortion degradation at high frequencies can be made by using A1 as a simple inverting amplifier, and by putting back to back zeners in the feedback loop of A3.

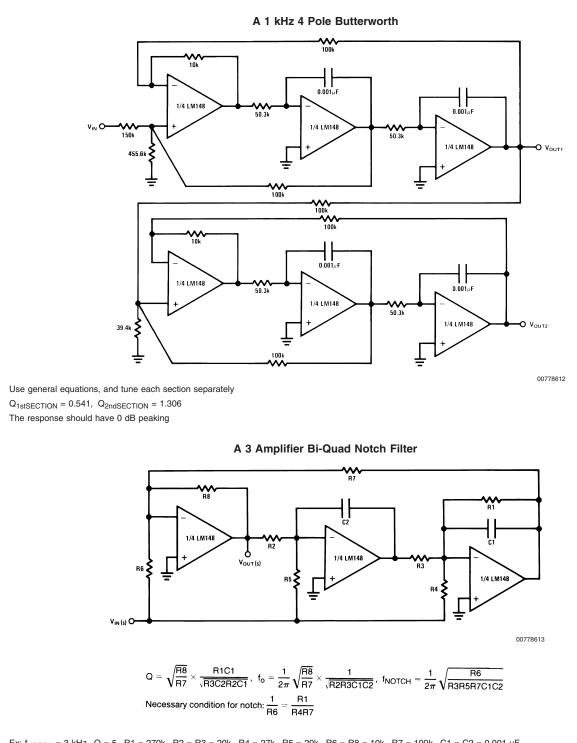
Typical Applications—LM148 (Continued)



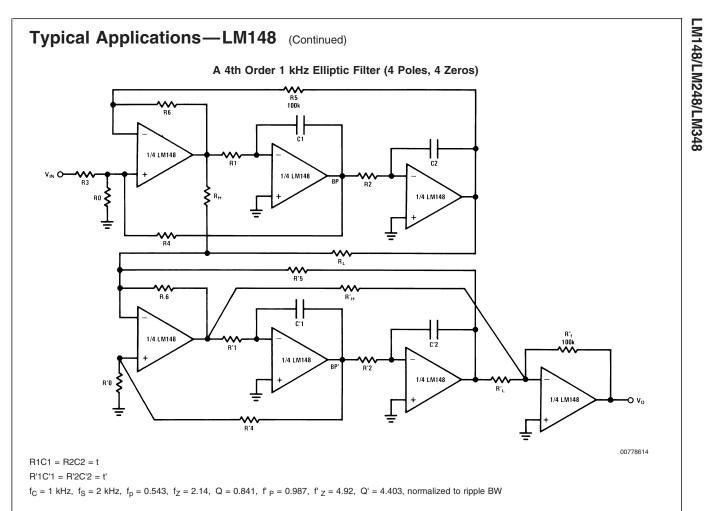


Typical Applications—LM148 (Continued)

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 $Ex: f_{NOTCH} = 3 \text{ kHz}, \text{ } Q = 5, \text{ } R1 = 270 \text{k}, \text{ } R2 = R3 = 20 \text{k}, \text{ } R4 = 27 \text{k}, \text{ } R5 = 20 \text{k}, \text{ } R6 = R8 = 10 \text{k}, \text{ } R7 = 100 \text{k}, \text{ } C1 = C2 = 0.001 \text{ } \mu\text{F}$ Better noise performance than the state-space approach.



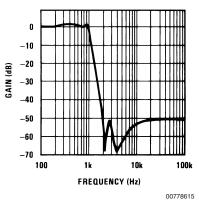
 $f = \frac{1}{2\pi R1C1} \times \sqrt{K}, K = \frac{R4R5}{R3} \left(\frac{1}{r_{DS}} + \frac{1}{R4} + \frac{1}{R5}\right), \quad r_{DS} \approx \frac{R_{ON}}{\left(1 - \frac{V_{GS}}{V_P}\right)^{1/_2}}$

Use the BP outputs to tune Q, Q', tune the 2 sections separately

 $R1 = R2 = 92.6k, R3 = R4 = R5 = 100k, R6 = 10k, R0 = 107.8k, R_L = 100k, R_H = 155.1k,$

 $R'1 = R'2 = 50.9k, \ R'4 = R'5 = 100k, \ R'6 = 10k, \ R'0 = 5.78k, \ R'_L = 100k, \ R'_H = 248.12k, \ R'f = 100k. \ All \ capacitors \ are \ 0.001 \ \mu F.$

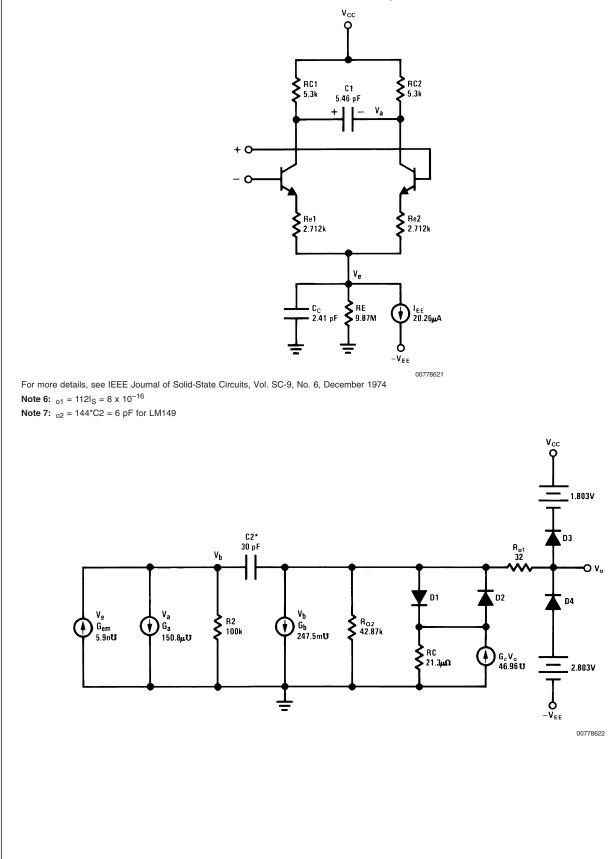
Lowpass Response



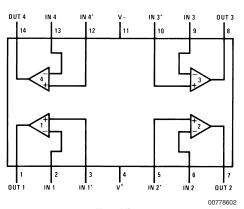
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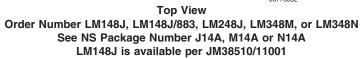
Typical Simulation



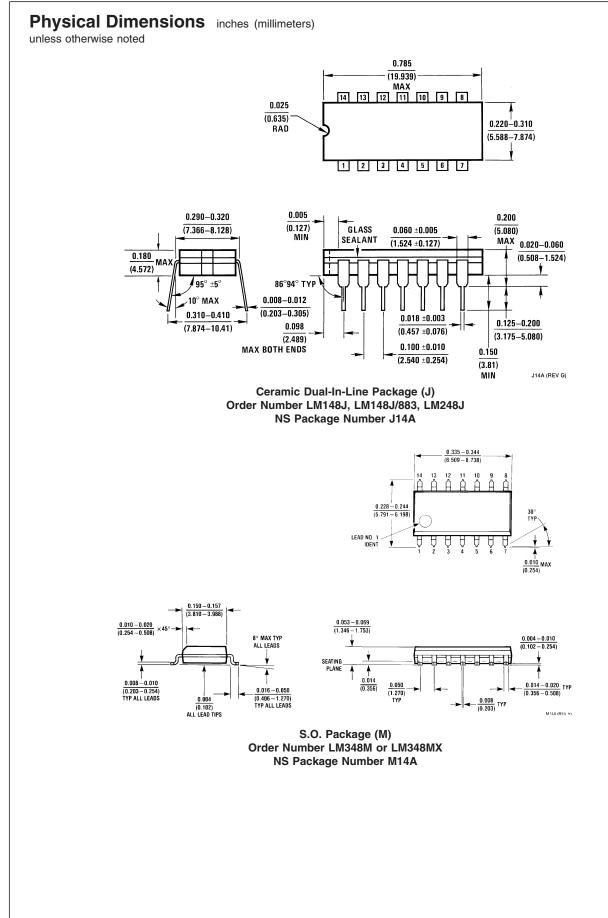


Connection Diagram

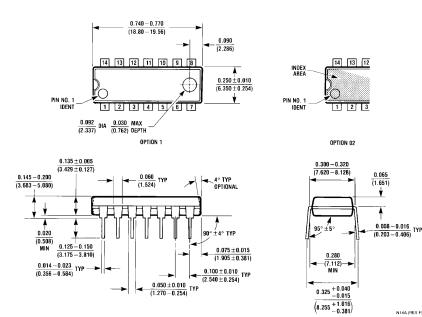




LM148/LM248/LM348



Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Molded Dual-In-Line Package (N) Order Number LM348N **NS Package Number N14A**

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